FROM TREXLER ETAL.

(MON) 10. 25' 04 13:57/ST. 13:56/NO. 4860347040 P

Amendments to the Claims:

1. (Currently Amended) Λ method of wetting a semiconductor wafer with slurry, said

method comprising: using a wear ring to hold the wafer to a polishing pad, said wear ring

including at least one inlet; at least one peripheral channel in the wear ring, said inlet being in

communication with said channel; and a plurality of outlets in communication with the at least

one peripheral channel in the wear ring; injecting the slurry into the at least one channel inlet

such that the slurry goes into the peripheral channel in the wear ring, exits the outlets, in the wear

ring and contacts the polishing pad.

2. (Original) A method as recited in claim 1, further comprising pressing the wear

ring against the polishing pad.

3. (Original) A method as recited in claim 1, wherein the polishing pad is disposed

on a polishing table and said method further comprises rotating at least one of the wear ring and

the polishing table.

4. (Original) A method as recited in claim 1, wherein the polishing pad is disposed

on a polishing table and said method further comprises rotating both the wear ring and the

polishing table.

5. (Cancelled)

Serial No.: 10/607,116

Art Unit: 3723

Page 2

FROM TREXLER ETAL.

(MON) 10. 25' 04 13:58/ST. 13:56/NO. 4860347040 P 6

6. (Currently Amended) A wear ring which is configured to hold a semiconductor

wafer and is configured to be disposed on a polishing pad, said wear ring including at least one

inlet; at least one peripheral channel in the wear ring, said inlet being in communication with said

channel; and a plurality of outlets in communication with the at least one peripheral channel in

the wear ring, said wear ring configured such that slurry is injectable into the at least one channel

inlet such that the slurry goes into the peripheral channel in the wear ring, exits the outlets, in the

wear ring and contacts the polishing pad.

7. (Original) A wear ring as recited in claim 6, wherein said wear ring is pressable

against the polishing pad.

8. (Cancelled)

Serial No.: 10/607,116

Art Unit: 3723

Page 3